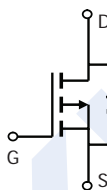
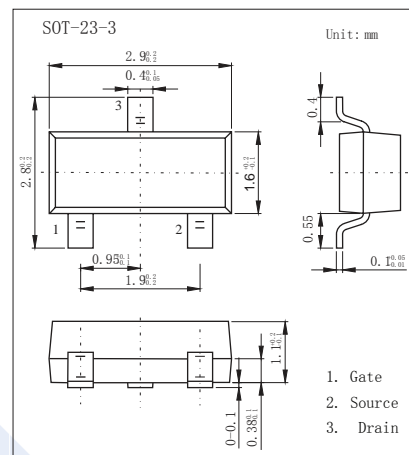


P-Channel MOSFET

KI2345

■ Features

- $V_{DS} (V) = -30V$
- $R_{DS(ON)} \leq 68m\Omega @ V_{GS} = -10V$
- $R_{DS(ON)} \leq 80m\Omega @ V_{GS} = -4.5V$
- $R_{DS(ON)} \leq 100m\Omega @ V_{GS} = -2.5V$
- Super high density cell design for extremely low $R_{DS(ON)}$
- Exceptional on-resistance and maximum DC current capability

■ Absolute Maximum Ratings $T_a = 25^\circ C$ Unless Otherwise Noted

Parameter	Symbol	Rating	Unit
Drain-source voltage	V_{DS}	-30	V
Gate-source voltage	V_{GS}	± 12	V
Continuous drain current	I_D	@ $T_a = 25^\circ C$	-4.2
		@ $T_a = 70^\circ C$	-3.5
Pulsed drain current	I_{DM}	-30	A
Power dissipation	P_D	@ $T_a = 25^\circ C$	1.4
		@ $T_a = 70^\circ C$	1.0
Single plus avalanche energy (L=0.1mH)	E_{AS}	40	mJ
Thermal Resistance-Junction to Case	$R_{\theta JC}$	50	$^\circ C/W$
Thermal Resistance-Junction-to-Ambient (Note 1)	$R_{\theta JA}$	90	$^\circ C/W$
Operating junction and storage temperature range	T_j, T_{stg}	-55 to +150	$^\circ C$

Note: 1. The device mounted on 1in2 FR4 board with 2 oz copper

P-Channel MOSFET

KI2345

■ Electrical Characteristics Ta = 25°C Unless Otherwise Specified

Parameter	Symbol	Testconditions	Min	Typ	Max	Unit
Drain-source breakdown voltage	V _{DSS}	V _{GS} = 0 V, I _D = -250 μA	-30			V
Gate threshold voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = -250 μA	-0.6		-1.3	V
Zero gate voltage drain current	I _{DSS}	V _{DS} = -24 V, V _{GS} = 0 V			-1	μA
Gate-body leakage	I _{GSS}	V _{DS} = 0 V, V _{GS} = ±12 V			±100	nA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = -10 V, I _D = -4.2 A			68	mΩ
		V _{GS} = -4.5 V, I _D = -4.0 A			80	
		V _{GS} = -2.5 V, I _D = -2.0 A			100	
On-state drain current (Note 2)	I _{D(on)}	V _{DS} = -5 V, V _{GS} = -10 V	-30			A
Forward transconductance	g _{fs}	V _{DS} = -5 V, I _D = -3. A	7			S
Input capacitance	C _{iss}	V _{DS} = -15V, V _{GS} = 0, f = 1 MHz		710		pF
Output capacitance	C _{oss}			70		
Reverse transfer capacitance	C _{rss}			20		
Total gate charge	Q _g	V _{DS} = -15V, V _{GS} = -4.5 V, I _D = -4.0 A		9		nC
Gate-source charge	Q _{gs}			2.3		
Gate-drain charge	Q _{gd}			2		
Turn-on Delay time	t _{d(on)}	V _{DS} = -4V, R _L = 6.0Ω, V _{GS} = -10V, R _G = 6Ω		37		ns
Turn-on Rise time	t _r			23		
Turn-off Delay time	t _{d(off)}			46		
Turn-off Fall time	t _f			3		
Diode forward voltage	V _{SD}	I _S = -1.0 A, V _{GS} = 0 V			-1.0	V

Note: 2. Pulse test: PW ≤ 300 μs duty cycle ≤ 2%.

■ Marking

Marking	A18E
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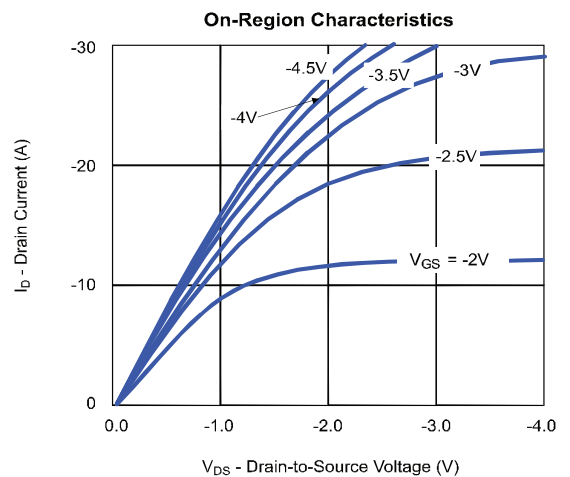
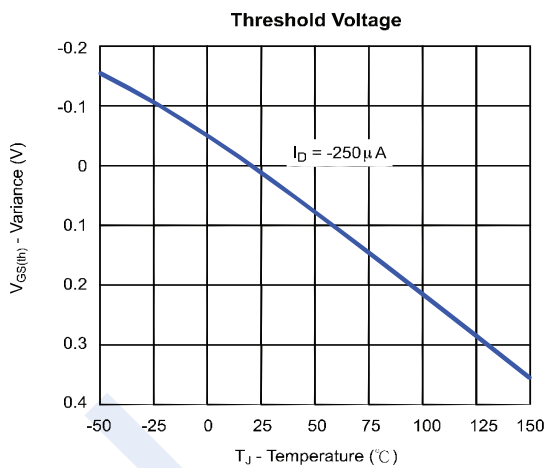
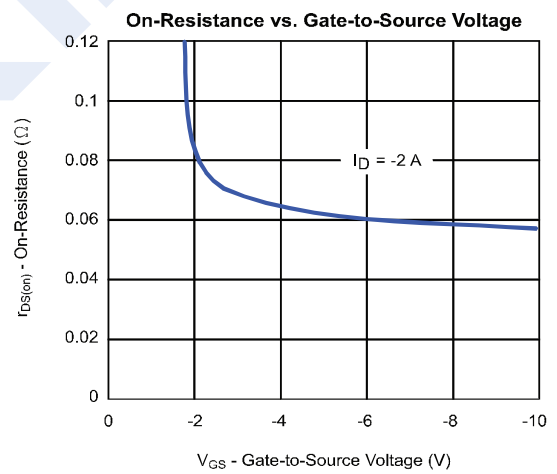
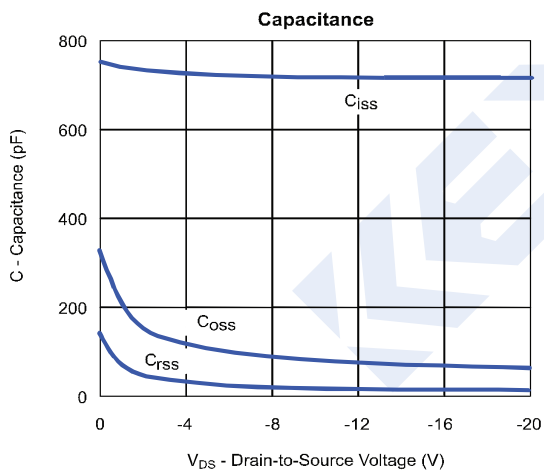
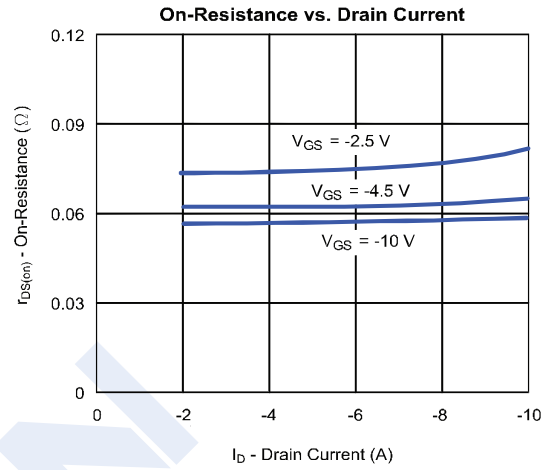
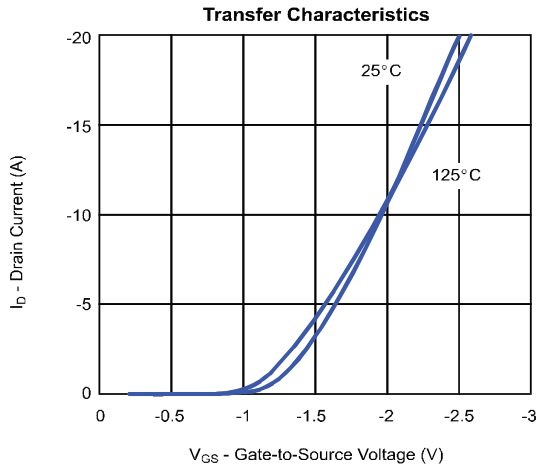
■ Ordering Information

Deviece	Packaging	Shipping
KI2345	SOT23-3	3000/Tape&Reel

P-Channel MOSFET

KI2345

Typical Characteristics



P-Channel MOSFET

KI2345

